

BFR340L3

Low Noise Silicon Bipolar RF Transistor

- Low voltage/ Low current operation
- Transition frequency of 14 GHz
- High insertion gain
- Ideal for low current amplifiers and oscillators
- Pb-free (RoHS compliant) and halogen-free thin small leadless package
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BFR340L3	FA	1 = B	2 = E	3 = C	TSLP-3-1

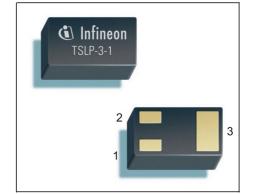
Maximum Ratings at T_{A} = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	6	V
Collector-emitter voltage	V _{CES}	15	
Collector-base voltage	V _{CBO}	15	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	10	mA
Base current	/ _B	2	
Total power dissipation ¹⁾	P _{tot}	60	mW
<i>T</i> _S ≤ 120°C			
Junction temperature	TJ	150	°C
Storage temperature	T _{Stg}	-55 150	

Thermal Resistance			
Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	500	K/W

 ${}^{1}T_{S}$ is measured on the collector lead at the soldering point to the pcb

²For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)





Parameter	Symbol	Values			Unit
		min.	typ.	max.	1
DC Characteristics			•	•	
Collector-emitter breakdown voltage	V _{(BR)CEO}	6	9	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0					
Collector-emitter cutoff current	I _{CES}	-	-	10	μA
$V_{\rm CE}$ = 15 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 5 \text{V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB} = 1 \text{V}, I_{\rm C} = 0$					
DC current gain	h _{FE}	90	120	160	-
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 3 V, pulse measured					

Electrical Characteristics at T_A = 25 °C, unless otherwise specified



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	1			
Transition frequency	f _T	10	14	-	GHz
$I_{\rm C}$ = 6 mA, $V_{\rm CE}$ = 3 V, f = 1 GHz					
Collector-base capacitance	C _{cb}	-	0.17	0.4	pF
$V_{CB} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.13	-	
$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	0.12	-	
$V_{\rm EB}$ = 0.5 V, <i>f</i> = 1 MHz, $V_{\rm CB}$ = 0 ,					
collector grounded					
Minimum noise figure	NF _{min}	-	1.15	-	dB
<i>I</i> _C = 1 mA, <i>V</i> _{CE} = 3 V, <i>Z</i> _S = <i>Z</i> _{Sopt} , <i>f</i> = 1.8 GHz					
Power gain, maximum stable ¹⁾	G _{ms}	-	17.5	-	-
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
$Z_{\rm L} = Z_{\rm Lopt}, f = 1.8 {\rm GHz}$					
Power gain, maximum available ¹⁾	G _{ma}	-	13	-	dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 3 {\rm GHz}$					
Transducer gain	S _{21e} ²				dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 1.8 GHz		-	14	-	
f = 3 GHz		-	10	-	
Third order intercept point at output ²⁾	IP3	-	12.5	-	dBm
V _{CE} = 3 V, <i>I</i> _C = 5 mA, <i>f</i> = 1.8 GHz,					
$Z_{\rm S} = Z_{\rm L} = 50\Omega$					
1dB compression point at output	P _{-1dB}	-	-1	-	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 1.8 GHz					

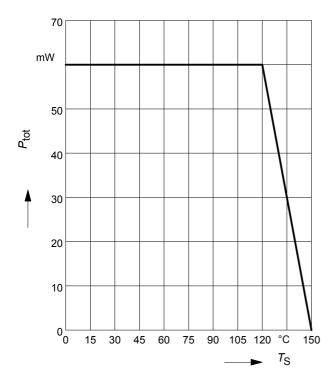
Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

 ${}^{1}G_{\mathsf{ma}} = |S_{21\mathrm{e}} / S_{12\mathrm{e}}| \; (\mathrm{k} \cdot (\mathrm{k}^{2} \cdot 1)^{1/2}), \; G_{\mathsf{ms}} = |S_{21\mathrm{e}} / S_{12\mathrm{e}}|$

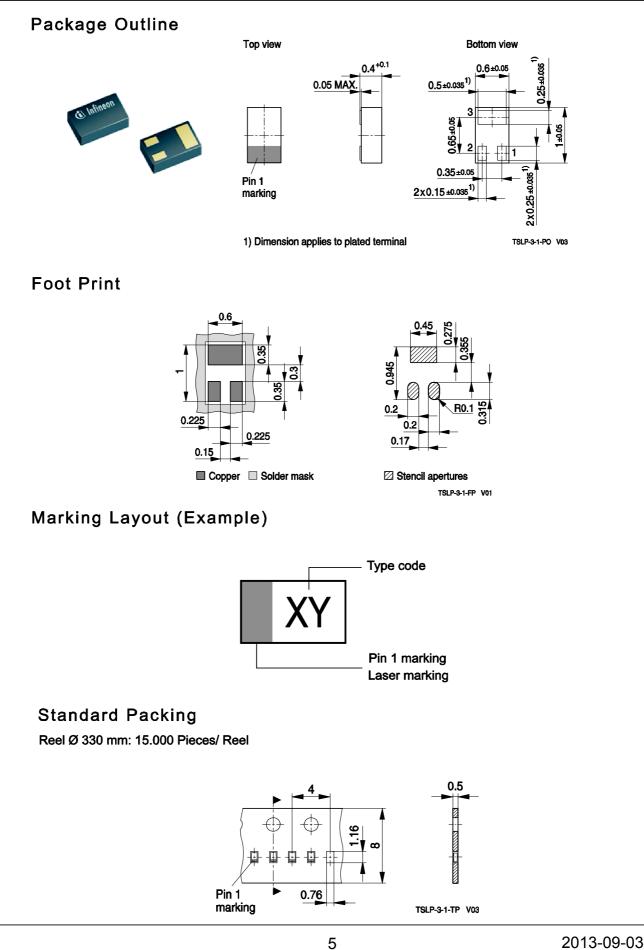
 2 IP3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.1 MHz to 6 GHz



Total power dissipation $P_{tot} = f(T_S)$









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